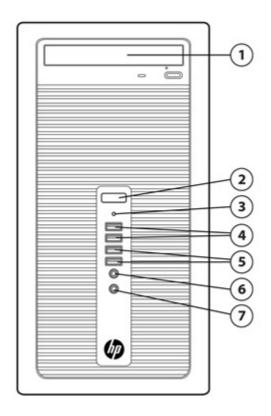
Overview

HP ProDesk 490 G1 Microtower Business PC



- 1. Drive bay supporting an optical disk drive (optional)
- 2. Power button
- 3. PC status LED
- 4. (2) USB 3.0 ports (black)
- 5. (2) USB 2.0 ports (blue)
- 6. 3.5mm microphone jack
- 7. 3.5mm headphone output

Not Shown

- 5.25" External Drive Half-Height Drive Bay (located behind removable bezel)
- 3.5" external drive bay; used for installing a Media Card Reader

Slots (1) PCI Express x16 graphics connectors;

- (3) PCI Express x1 accessory connectors
- (1) USB 3.0 header for media card reader
- (1) Parallel port (optional)



Overview

Bays (2) 3.5" internal storage drive bays

Rear I/O (4) USB 2.0 ports; (2) USB 3.0 ports

(1) VGA video port; (1) DVI-D video port; DisplayPort with Multi-Stream support - DP 1.2 (Optional)

(1) RJ-45 network connector

(1) RS-232 serial port

(1) RS-232 serial (optional)

3.5mm audio in/out jacks

PS/2 keyboard and mouse ports



Overview

At A Glance

- Expandable, upgradable chassis and system board
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel® H87 Express chipset supporting Intel® 4th generation Core processors, featuring integrated Intel HD Graphics Realtek RTL8151GH-CG GbE LOM integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Three independent monitor support via VGA and DVI-D video interfaces and optional DisplayPort with Multi-stream support DP 1.2
- Discrete graphics options available for all platforms
- DTS Sound + audio management software
- Standard and high efficiency energy saving power supply options
- ENERGY STAR® qualified models certified EPEAT® Gold
- Can be configured with multiple drives in a RAID array
- Optional Intel Smart Response Technology disk cache modules
- 1 20GB SATA SSD Cache*



^{*} Intel 313 Series Hawley Creek SSDMAEXCO20G301 mSATA 20GB SATA II SLC Internal Solid State Drive (SSD)

Standard Features and Configurable Components (availability may vary by country)

OPERATING SYSTEM

Preinstalled When Purchased Windows 8.1 Pro (64-bit) Windows 8.1 (64-bit)

Windows 7 Ultimate (32-bit)**
Windows 7 Ultimate (64-bit)**
Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)***
Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)***

Windows 7 Home Premium (32-bit)**
Windows 7 Home Premium (64-bit)**
Windows 7 Home Basic (32-bit)**

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

Intel® 4th Generation Core™ i7 Processors

Intel® Core™ i7-4770 Processor
Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency)
8 MB cache, 4 cores, 8 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i7-4771 Processor

Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency)

8 MB cache, 4 cores, 8 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i7-4770S Processor

Up to 3.9 GHz Max. Turbo Frequency (3.1 GHz base frequency)

8 MB cache, 4 cores, 8 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate



Standard Features and Configurable Components (availability may vary by country)

Intel® 4th Generation Core™ i5 Processors

Intel® Core™ i5-4570 Processor

Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency)

6 MB cache, 4 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i5-4570S Processor

Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency)

6 MB cache, 4 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i5-4670 Processor

Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency)

6 MB cache, 4 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i5-4670S Processor

Up to 3.8 GHz Max. Turbo Frequency (3.1 GHz base frequency)

6 MB cache, 4 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i5-4430 Processor

Up to 3.2 GHz Max. Turbo Frequency (3.0 GHz base frequency)

6 MB cache, 4 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i5-4430s Processor

Up to 3.2 GHz Max. Turbo Frequency (2.7 GHz base frequency)

6 MB cache, 4 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® 4th Generation Core™ i3 Processors

Intel® Core™ i3-4340 Processor

Up to 3.6 GHz Max. Turbo Frequency (3.6 GHz base frequency)

4 MB cache, 2 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4330 Processor

Up to 3.5 GHz Max. Turbo Frequency (3.5 GHz base frequency)

4 MB cache, 2 cores, 4 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate



Standard Features and Configurable Components (availability may vary by country)

Intel® Core™ i3-4130 Processor

Up to 3.4 GHz Max. Turbo Frequency (3.4 GHz base frequency) 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium Processors

Intel® Pentium G3430 Processor

Up to 3.3 GHz Max. Turbo Frequency (3.3 GHz base frequency)

3 MB cache, 2 cores, 2 threads

Intel HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium G3420 Processor

Up to 3.2 GHz Max. Turbo Frequency (3.2 GHz base frequency)

3 MB cache, 2 cores, 2 threads

Intel HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium G3220 Processor

Up to 3.0 GHz Max. Turbo Frequency (3.0 GHz base frequency)

3 MB cache, 2 cores, 2 threads

Intel HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Celeron Processors

Intel® Celeron™ G1820 Processor

2.7 GHz base frequency

2 MB cache, 2 cores, 2 threads

Intel HD Graphics

Supports DDR3 memory up to 1333 MT/s data rate

Available February '14

Intel® Celeron™ G1830 Processor

2.8 GHz base frequency

2 MB cache, 2 cores, 2 threads

Intel HD Graphics

Supports DDR3 memory up to 1333 MT/s data rate

Available February '14

CHIPSET

Intel® 8 Series (H87 Express) Chipset



Standard Features and Configurable Components (availability may vary by country)

GRAPHICS

Intel HD Graphics on all models (integrated on processor)

AMD Radeon HD 8350 (1GB) FH PCIe x16

AMD Radeon HD 8350 (1GB) PCIe x16

AMD Radeon HD 8470 (2GB) FH

AMD Radeon HD 8490 (1GB) PCIe x16

NVIDIA GeForce GT630 (2GB) FH PCIe x16

NVIDIA NVS 310 x16 1st (no cbl)

NVIDIA NVS 315 (1GB) PCIe x1

ADAPTERS AND CABLES

HP DMS-59 to Dual DisplayPort Cable

HP DMS-59 to Dual DVI Cable

HP DMS-59 to Dual VGA Cable

HP DisplayPort to DisplayPort Cable

HP DisplayPort to DVI-D Adapter

HP DisplayPort to HDMI Adapter

HP DisplayPort to VGA Adapter

HP Serial Port Adapter

HP Parallel Port Adapter

HP DisplayPort Cable

STORAGE

SATA Drives

500 GB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 3.5"

1 TB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 3.5"

2 TB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 3.5"

Hybrid Drives

500 GB SATA 6G 2.5 (8GB cache) SSHD Drive

(with 3.5" adapter)

500 GB SATA 6G 2.5 2nd Drive (8 GB cache) SSHD Drive

(with 3.5" adapter)

1 TB SATA 6G 2.5 (8 GB cache) SSHD Drive

(with 3.5" adapter)

1 TB SATA 6G 2.5 2nd Drive (8 GB cache) SSHD Drive

(with 3.5" adapter)

Solid State Drives

mSATA 20GB SATA II SLC Internal SSD



Standard Features and Configurable Components (availability may vary by country)

128 GB SATA 6G 2.5 SSD (with 3.5" adapter) 128 GB SATA 6G 2.5 2nd SSD (with 3.5" adapter)

Self-encrypting Solid State Drive

120 GB SATA 2.5" Opal1 (SED) Solid State Drive with caddy
180 GB SATA 2.5" Opal1 (SED) Solid State Drive with caddy
256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive
(with 3.5" adapter)
256 GB SATA 2.5" 2nd Self-Encrypting (SED) Solid State Drive installed w/caddy

Optical Disc Drive

Blu-ray BDXL Writer SuperMulti DVD Writer DVD-ROM

Media Card Reader

15-in-1 USB2/3 Media Card Reader

MEMORY

Form Factor	Туре	Maximum	# of Slots
Microtower	DDR3 non-ECC	32 GB	4 UDIMM
	Up to 1600 MT/s		

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

PERFORMANCE

Intel® Smart Response Technology Disk Cache Modules

32GB SATA Solid State Disk Cache*

*Intel® Smart Response Technology disk cache modules planned to be available December, 2013.



Standard Features and Configurable Components (availability may vary by country)

NETWORKING/COMMUNICATIONS

Ethernet (RJ-45)

Realtek RTL8151GH-CG GbE LOM (standard)
Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)

Wireless

Intel® Dual Band Wireless-N 7260 802.11 a/b/g/n PCI Express (optional)*
*Intel® Dual Band Wireless-N 7260 planned to be available December, 2013.

AUDIO/MULTIMEDIA

HD audio with Realtek ALC221 codec (all ports are stereo)
DTS Studio Sound audio management technology
Microphone and headphone front ports (3.5mm)
Line-out and Line-In rear Ports (3.5mm)
Multi-streaming capable
Internal speaker (standard)

KEYBOARDS AND POINTING DEVICES

Keyboard

HP PS/2 Keyboard

HP USB Keyboard

USB Smart Card (CCID) Keyboard

HP USB and PS/2 Washable Keyboard

HP Wireless Keyboard and Mouse Combo*

* Keyboard contains 25% post-consumer recycled plastic material.

Mice

HP PS/2 Mouse

HP USB Mouse

HP USB 1000dpi Laser Mouse

HP USB and PS/2 Washable Mouse



Standard Features and Configurable Components (availability may vary by country)

HP BIOS

Key features of the HP BIOS include:

- UEFI specification 2.3.1
- Absolute Persistence Agent To ensure tracking and tracing services remains active, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so
 component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in
 any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the BIOS has the capability to replicate settings across all like systems in the Enterprise using the Replicated Setup option in BIOS Setup, or using tools available from the HP support website in the Business Desktop BIOS Utilities and BIOS Configuration Utility packages.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be
 made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration management, allowing operating systems and applications to manage power based on activity and usage.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5
 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

MANAGEABILITY

Fully manageable and supported by industry-standard HP Client Management Solutions. Optional LANDesk management tools simplify mobile device management and security. Simplify everything from deployment or migration to daily management, security, licensing, and more-and stop downtime before it starts.

- Hardware Management: Inventory, Device config and BIOS updates, HW alerting, Driver updates
- Software Management: Deployment, App Management, Patch Management; Deployment and Migration; Proactive HW and SW Management; Mobile Users and Device Management; Remote Assistance / Help Desk
- LANDesk Management Suite 9.5 (LDMS) optional contact HP representative for part numbers
- Hardware integration with Microsoft System Center Configuration Manager: Client Integration Kit (CIK), Client Catalog, Client Driver Packs
- HP SoftPaq Download Manager (SDM)
- HP System Software Manager (SSM)
- HP BIOS Configuration Utility (BCU)
- HP Driver Packs
- HP Client Management Interface (HP CMI)
- Absolute Persistent Software.



Standard Features and Configurable Components (availability may vary by country)

SECURITY

Trusted Platform Module (TPM) 1.2 (Common Criteria EAL4+ certified)	N/A
SATA port disablement (via BIOS)	X
Drivelock	N/A
RAID configurations	X
Intel® Identify Protection Technology (IPT)*	N/A
Serial, parallel, USB enable/disable (via BIOS)	X
Optional USB Port Disable at factory (user configurable via BIOS)	X
Removable media write/boot control	X
Power-On password (via BIOS)	X
Administrator password (via BIOS)	X
HP Chassis (1 bay) Security Kit	X
Solenoid Hood Lock / Sensor	N/A
Support for chassis padlocks and cable lock devices	N/A

^{*}Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module.

ENVIRONMENTAL & REGULATORY

ENERGY STAR® qualified models available

EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.

Low halogen (chassis, all internal components and modules)

TAA compliant

PORTS

I/O Ports - Standard

USB 2.0	2 (front); 4 (rear)
USB 3.0	2 (front); 2 (rear); 1(internal)
Serial (RS-232)	1
PS/2	1 keyboard (purple) 1 mouse (green)
Video	1 VGA
	1 DVI-D

NOTE: When configured with an Intel Celeron, Pentium or 4th generation Intel Core i3 CPU only two of the available video output ports are active

Audio Front:

headphone/mic Rear: line in/out 3.5mm diameter



Standard Features and Configurable Components (availability may vary by country)

RJ-45 Network Interface	1
I/O Ports - Optional	
DisplayPort with Multi-Stream support - DP 1.2	1
2nd Serial (RS-232)	1
Parallel	1
PCI Express Mini Card	N/A
MXM Graphics	N/A
mSATA	N/A
PCI Express x1 (v2.0)	3 4.2" full height 6.6" length 10W max. power
PCI Express x16 (v2.0) (wired as a x4)	N/A
PCI Express x16 (v3.0)	1 4.2" full height 6.6" length 75W max. power
Optional PCI (v2.3)	N/A
BAYS	
5.25" external storage drive	1
3.5" external storage drive	1
5.25" ODD	1
Slim ODD	N/A
2.5" internal storage drive	N/A
3.5" internal storage drive	2

SERVICE AND SUPPORT

On-site Warranty¹: One-year (1-1-1) limited warranty delivers one year of on-site, next business day² service for parts and labor and includes free telephone support³ 24 x 7. One-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.



Technical Specifications – Operating Systems and Software

OPERATING SYSTEMS

Preinstalled Windows 8.1 Pro (64-bit)*

Windows 8.1 (64-bit)*

Windows 7 Ultimate (32-bit)** Windows 7 Ultimate (64-bit)** Windows 7 Professional (32-bit)** Windows 7 Professional (64-bit)**

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)*** Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)***

Windows 7 Home Premium (32-bit)** Windows 7 Home Premium (64-bit)** Windows 7 Home Basic (32-bit)**

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

For all Preinstalled operating systems HP provides Microsoft WHQL certified (where applicable) drivers on www.hp.com at the time of product announcement.

Web Support Windows 7 Enterprise (32-bit or 64-bit)

For all Supported operating systems HP performs testing of the OS, and makes available all HP value add software (OS dependent). Certified drivers are made available on www.hp.com within 30 days of product announcement.

Certified Novell SUSE Linux Enterprise Desktop 111

Red Hat Enterprise Linux 641

For all Certified operating systems HP will submit hardware to the operating system vendor for testing and certification. All drivers would be obtained from the operating system vendor, not supplied by HP. Certification will be posted by the operating system vendor.

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows® 7 Professional software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

¹The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet Plus
- HP Media Card Reader
- HP Client Security
- HP Blu-ray Writer playback of commercial movies
- HP 2nd serial port adapter
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

The following features are not supported by Red Hat Enterprise Linux 64:



Technical Specifications – Operating Systems and Software

- TPM v1.2 embedded Security Chip
- Intel Gigabit CT Desktop NIC
- HP Wireless 802.11b/g/n NIC
- HP Media Card Reader
- HP Blu-ray Writer
- HP 2nd serial port Adapter
- HP USB Smart Card (CCID) Keyboard
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Included	Windows 7	Windows 8.1
Security	HP Client Security: HP Drive Encryption (FIPS 140-2) HP Device Access Manager with Just In Time Authentication HP Password Manager HP File Sanitizer (SSDs and Hybrid Drives not supported) HP Disk Sanitizer External Edition ¹ Microsoft Security Essentials	Disk Sanitizer External Edition ¹ Microsoft Defender
MultiMedia	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)
Communication		HP Wireless Hotspot
HP Value Add	HP ePrint Driver ² HP PageLift HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver ² HP PageLift HP Recovery Manager HP Support Assistant
3rd Party	Adobe Flash Player Bing Search for Internet Explorer 10 Box PDF Complete, Corporate Edition Skype	Bing Search PDF Complete, Corporate Edition Skype
Microsoft Products	Buy Office	Buy Office

¹Available via download.



²Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see: www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

Technical Specifications - Graphics

Intel HD Graphics

VGA Controller Integrated

DisplayPort Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream

Technology for a maximum of 2 displays (including the integrated panel)

Bus Type N/A RAMDAC N/A

Memory Intel graphics do not have dedicated memory but utilizes some of the computer's system memory

The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio

Video Playback) support for playback of protected video content.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Maximum Graphics MemoryMicrosoft Windows 7Windows 8.1

Up to 1.7GB Up to 1.8GB

NOTE: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

Maximum Color Depth 32 bits/pixel

Graphics/Video API Support 4th Generation Core processors:

- The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.
- Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
 - Encode/transcode HD content
 - Playback of high definition content including Blu-ray Disc
 - O Superior image quality with sharper, more colorful images
- DirectX Video Acceleration (DXVA) support for accelerating video processing
 - Full AVC/VC1/MPEG2 HW Decode
- Advanced Scheduler 2.0, 1.0
- Windows 7, Windows 8.1, Linux OS Support
- DirectX 11.1
- OpenGL 4.0
- Open CL 1.2

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP



Technical Specifications - Graphics

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz

^{*} Only supported on displays connected to the external DisplayPort connector.

AMD Radeon HD 8470 Graphics Card

Form Factor Full Height

Graphics Controller AMD Radeon HD 8470

Core Clock 775MHz Memory Clock 900MHz

Memory 2GB, DDR3, 64-bit wide

Bus Type PCIe Gen2 **Max. Power** < 30W

Power Source Support 12V and 3.3V

3D API Support DX11 **HDCP Support** Yes

Display Max. ResolutionDigital 2560 x 1600
Analog 2048 x 1536

Supported Graphics APIs DX11, OpenGL, full 1080p BD (H264) playback in hardware, HDMI 1.4 support



Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
800 x 600	60 Hz
1024 x 768	60 Hz
1280 x 720	60 Hz
1280 x 768	60 Hz
1280 x 1024	60 Hz
1360 x 768	60 Hz
1440 x 900	60 Hz
1600 x 900	60 Hz
1680 x 1050	60 Hz
1920 x 1080	60 Hz

NVIDIA NVS 310 Graphics Card

Introduction The NVIDIA® NVS™ 310 Graphics Card is a PCI Express low profile form factor graphics add-in card

targeted as an active low cost graphics solution for the corporate business and enterprise markets.

The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form factor

graphics add-in card for either standard or small form factor PC designs.

Performance and Features The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is capable of

supporting up to 2 displays.

DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI

monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.

For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.

Form Factor Low Profile: 2.713 × 6.15 in

Graphics Controller NVIDIA® NVS 310

Memory Clock875MHzMemory Size512 MB DDR3Memory Bandwidth14 GB/sMax. Power19.5W

Display Max. Resolution Up to 2560 x 1600 (digital display) per display

Display Output Up to 2 displays in the following configurations

DisplayPort output:

• Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310

 Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology

technology.

graphics card



Technical Specifications - Graphics

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60
 Hz with reduced blanking using DisplayPort to DVI-D single-link
 cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

Drives two analog display at resolutions up to 1920 x 1200 at 60
 Hz using DisplayPort to VGA cable adaptors

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz) by Connection			
	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60



Technical Specifications - Graphics

NVIDIA NVS 315 1GB PCIe x 16 Graphics Card

Introduction Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with the

NVIDIA NVS 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for professional

business and commercial applications.

Performance and Features The NVIDIA® NVS 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of

supporting up to 2 displays.

DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI

monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.

For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.

Form Factor Low Profile: 2.713 × 6.15 in

Graphics Controller NVIDIA® NVS 315

Memory Clock875MHzMemory Size512 MB DDR3Memory Bandwidth14 GB/s

Connectors DMS-59 , with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter cable

Display Max. Resolution Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort

Display Output Up to 2 displays in the following configurations

Dual DVI:

 Drives two DVI displays using optional HP DMS59 DVI Dual-head Connector Cable DL139A

Dual DisplayPort:

O Drives two DisplayPort using optional HP DMS-59 to Dual DisplayPort kit XP688AA

Dual VGA:

Drives two analog using the included HP DMS-59 to Dual VGA Cable

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	n Maximum Refresh Rates (Hz) by Connection	
	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	60



Technical Specifications - Graphics

1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60*
2560 x 1600	N/A	60*

^{*} Display Port Only

NVIDIA GeForce GT630 Graphics Card

Introduction

The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.

An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.

Performance and Features

The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:

- Unprecedented flexibility for new applications and enhanced performance
- Support for NVIDIA surround technology
- Run multiple displays from a single graphics card
- Full 16 lane PCIe Generation 3 bus support with peak bandwidth support
- Wireless Display ready for future support

Form Factor PCIe x16 Card

Graphics Controller NVIDIA Kepler Architecture GPU

Core Clock 875 MHz
Memory Clock 891 MHz

Memory Size 2 GB DDR3 128 bit

Memory Bandwidth 28.5 GB/s

Display Max. Resolution 2560 x 1600 digital, 2048 x 1536 analog

Display Support Integrated 400 MHz RAMDAC



Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz) by Connection	
	Analog Connection	Digital Connection
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60
2560 x 1600	N/A	60

AMD Radeon HD 8350 1GB PCIe x16 DH Graphics Card

Introduction Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB PCle x16

DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD

8350 GPU, great for Web conferencing or video and photo editing.

Form Factor PCie x16

Graphics Controller AMD Radeon HD 8350

Core Clock GPU engine operates at 523 MHz

Memory 1GB, DDR3, SDRAM

Memory Clock875 MHzHDCP SupportYes

Display Max. Resolution Digital 1920 x 1200

Analog 2048 x 1536



Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	N/A
2560 x 1600	N/A	N/A

AMD Radeon HD 8490 1GB PCIe x16 Graphics Card

Introduction Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express

x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor. Improve your

everyday PC, Web conferencing, and video or photo editing.

Form Factor PCie x16

Graphics Controller AMD Radeon HD 8490

Core Clock GPU engine operates at 875 MHz

Memory 1GB, DDR3, SDRAM

Memory Clock900 MHzHDCP SupportYes

Display Max. Resolution Digital 2560 x 1600

Analog 2048 x 1536



Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

	Analog Connection	Digital Connection
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 900	85	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60
2560 x 1600	N/A	60



Technical Specifications - Hard Disk and Solid State Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance. SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP ProDesk 490 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

SMART IV Technology

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

NOTE: GB = 1 billion bytes. Actual available capacity is less.

Redundant Array of Independent Drives (RAID)

Flexible implementation:

- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.
- DPS Self Test can be executed on physical hard drives while in RAID mode.

NOTE:

RAID 1 is the only RAID configuration offered via factory configurations. The pre-configured systems:

Are complete RAID systems and have both drives installed. If the MT is configured with three hard disk drives, the third drive is
would be un-partitioned and not part of the RAID array



Technical Specifications - Hard Disk and Solid State Storage

- Have the necessary Option ROM configuration.
- Are pre-loaded and pre-installed with all required Intel software.

Include a preinstalled operating system that is mirrored mode out of the box.

HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 1 TB

5,400 rpm +/- 0.2% **Spindle Speed**

Solid State Hybrid Drive (SSHD) technology with NAND Flash **Drive Type**

Interface Serial ATA (SATA)

Cache Buffer 64 MB **NAND Flash** 8 GB

Commercial Multilevel Cell

(cMLC)

Number of Sectors 976,773,168

Seek Time (typical reads) Single Track: 2.0 ms

> Average: 12 ms

Height 0.374 +/-.008 in (9.5 +/- 0.2 mm) Width

2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm) Length

Weight 0.254 lb/115 g (max) **Operating Temperature** 32° to 140° F (0° to 60° C)

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 500 GB

Spindle Speed 5,400 rpm +/- 0.2%

Drive Type Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface Serial ATA (SATA)

Cache Buffer 64 MB **NAND Flash** 8 GB

Commercial Multilevel Cell

(cMLC)

976,773,168 **Number of Sectors**

Seek Time (typical reads) Single Track: 2.0 ms

> Average: 12 ms

Height 0.268 +/-.008 in (6.8 +/- 0.2 mm) Width 2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm) Length

Weight 0.209 lb/95 g (max) 32° to 140° F (0° to 60° C) **Operating Temperature**



Technical Specifications - Hard Disk and Solid State Storage

HP 128 GB Solid State Drive

Unformatted Capacity 128 GB^{*}

Architecture Multi Level Cell (MLC) NAND

Interface SATA 6 GB/sec

Dimensions (W x H x D) 2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)

Weight 0.16 lb (73 g)

Bandwidth Performance Sustained Sequential Read: Up to 450 MB/ss

Sustained Sequential Write: Up to 260 MB/s
Random Read (4KB): up to 46K IOPs
Random Write (4KB): up to 56K IOPs
Read: 55ms (TYP)

Latency Read: 55ms (TYP)

Write: 55ms (TYP)

Power DC power requirement: Min 4.5 V; Max 5.5 V

Total power consumption: 160 mW (Active); <85 mW; (Idle)

Useful Drive Life 1.2 million device hours**

Environmental Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non-Relative Humidity (operating): 5% to 95% condensing)

Shock: 1,500 G/1.0 msec

Regulations UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS

CISPR 22:2002 Class B, Korea KCC, CE Mark

HP 256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive

Unformatted Capacity 256,186,209,271 bytes

Architecture Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface

InterfaceSerial ATA 2.0 (3.0 Gb/s)NAND Flash25nm MLC NAND Flash

 Height
 .275 in/7mm

 Width
 2.75 in/69.85 mm

 Length
 3.95 in/100.5 mm

 Weight
 0.161 lb (73 q)

Bandwidth Performance Sustained Sequential 128k Read: Up to 450 MB/s

Sustained Sequential 128k Write: Up to 260 MB/s Random 4k Read: Up to 46K IOPs Random 4k Write: Up to 56K IOPs

Latency Read: $55 \mu s$

Write: 55 µs

Power SATA power consumption: 160 mW (active average); <85 mW (idle average)

Useful Drive Life 72TB written, up to 40GB/day for 5 years



^{*} For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

^{**} The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

Technical Specifications - Hard Disk and Solid State Storage

Environmental Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non- Relative Humidity (operating): 5% to 95% **condensing)** Shock: 1,500 G/1 ms

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 1,000,204,886,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 32 MB

Logical Blocks 1,953,525,168

Seek Time (typical reads,
includes controller overhead,
including settling)Single Track:
Average:2.0 msAverage:
Full-Stroke:11 ms21 ms

Height (nominal) 1 in/2.54 cm

Width (nominal) Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)

HP 2-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Unformatted Capacity 2 TB

Rotational Speed 7,200 rpm

Interface SATA 6Gb/s NCQ

Cache, Multisegmented (MB) 64 MB

Seek Time (average) Read <8.5 ms

Write <9.5 ms

 Height
 1.028 in/26.11 mm

 Width
 4.0 in/101.6 mm

 Depth
 5.787 in/146.99 mm

Weight 1.38 lb/626 g

Operating Temperature 41° to 131° F (5° to 55° C)



Technical Specifications - Removable Storage

HP Blu-ray BDXL Writer Drive

Height5.25-inch, half-height, tray-loadOrientationEither horizontal or vertical

Interface type SATA

Disc capacity Blu-ray: 128 GB QL, 100 GB TL, 50 GB DL or 25 GB standard

DVD: 8.5GB DL or 4.7GB standard

Dimensions 5.8 x 1.7 x 7.1 in (14.8 x 4.2 x 18.0 cm) max

(W x H x D)

Weight 2.1 lb (950g)

(max)

Performance CD-ROM Read Access time Random 140 ms (typical)

Full Stroke 230 ms (typical) **DVD-ROM Read Access** Random 150 ms (typical) **time** Full Stroke 240 ms (typical) **BD-ROM Read Access time** Random 250 ms (typical)

Full Stroke 350 ms (typical)

Startup Time (Time to drive ready from tray loading)

BD-ROM (SL/DL) 28S / 28S

BD-R (SL/DL/TL/QL) 285 / 285 / 405 / 405 BD-RE (SL/DL/TL) 285 / 285 / 405 DVD-ROM (SL/DL) 185 / 185 DVD-R (SL/DL) 255 / 255 DVD-RW **25S** DVD+R (SL/DL) 255 / 255 DVD+RW **25S** DVD-RAM **35S**

CD-ROM 15S

CD Read speeds CD-ROM up to 40X

CD-R up to 40X CD-RW up to 40X

DVD Read speeds DVD-RAM up to 5X

DVD+/-RW up to 10X DVD+/-R up to 16X DVD+/-R DL up to 8X DVD-ROM up to 16X DVD-ROM DL up to 8X



Technical Specifications - Removable Storage

Blu-ray Read speeds BD-ROM (SL/DL) up to 8X

> BD-R (SL/DL) up to 8X BD-R (TL/QL) up to 6X BD-RE (SL/DL) up to 6X

BD-RE TL up to 4X

CD Write speeds CD-R up to 40X

CD-RW up to 24X

DVD Write speeds DVD+/-R up to 16X

> DVD+/-R DL up to 8X DVD+RW up to 8X DVD-RW up to 6X DVD-RAM up to 5X

Blu-ray Write speeds BD-R (SL/DL) up to 6X

BD-R (TL/QL) up to 4X

BD-RE (SL/DL/TL) up to 2X

Power Source SATA DC power receptacle

> **DC Power Requirement** 5 VDC ± 5%-100 mV ripple p-p

> > 12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC -1200 mA typical, 1500 mA maximum

12 VDC -1000 mA typical, 1500 mA maximum

Environmental (all conditions non-condensing) **Temperature (operating)** 41° to 122° F (5° to 50° C)

Relative Humidity

10% to 90% 86° F (30° C)

Maximum Wet Bulb

Temperature

HP SuperMulti DVD Writer Drive

Height 5.25-inch, half-height, tray-load

Orientation Either horizontal or vertical

Interface type SATA

Dimensions (W \times H \times D) 5.8 x 1.7 x 6.9 in (14.8 x 4.2 x 17.5 cm) max

Weight (max) 2.1 lb (950g)

> **CD-ROM Read Access** Random 120 ms typical

> > **Full Stroke** 200 ms typical

DVD-ROM Read Access Random 130 ms typical

> **Full Stroke** 240 ms typical

CD Media Read Transfer CD-ROM, CD-R Read Up to 6000 KB/s (40X)

> **CD-RW Read** Up to 4800 KB/s (32X)

Technical Specifications - Removable Storage

		Digital/Analog Audio Playback	Up to 2400 KB/s (16X)
	DVD Media Read Transfer	Digital Audio Extraction (CD-ROM, CD-R)	Up to 6000 KB/s (40X)
		Digital Audio Extraction (CD-RW)	Up to 4800 KB/s (32X)
		Video CD Playback	Up to 2400 KB/s (16X)
		DVD-ROM SL Read	Up to 21600 KB/s (16X)
		DVD-ROM DL Read	Up to 10800 KB/s (8X)
		DVD Video Playback	Up to 10800 KB/s (8X)
Performance		DVD Video SL (other than playback)	Up to 21600 KB/s (16X)
		DVD Video DL (other than playback)	Up to 10800 KB/s (8X)
		DVD+/-R	Up to 21600 KB/s (16X)
		DVD+/-R DL	Up to 10800 KB/s (8X)
		DVD+/-RW	Up to 10800 KB/s (8X)
		DVD-RAM	Up to 6750 KB/s (5X)
	CD Media Write Transfer	CD-R	Up to 6000 KB/s (40X)
		CD-RW	Up to 600 KB/s (4X)
		CD-RW (High speed)	Up to 1500 KB/s (10X)
		CD-RW (Ultra speed)	Up to 3600 KB/s (24X)
	DVD Media Write Transfer	DVD+/-R	Up to 21600 KB/s (16X)
		DVD+/-R DL	Up to 10800 KB/s (8X)
		DVD+RW	Up to 10800 KB/s (8X)
		DVD-RW	Up to 8100 KB/s (6X)
		DVD-RAM	Up to 6750 KB/s (5X)
	Media	Read	Write
	CD-ROM	Yes	No
	CD-R	Yes	Yes
	CD-RW	Yes	Yes
Media Compatibility	DVD-ROM	Yes	No
cara companionity	DVD-ROM DL	Yes	No



Technical Specifications - Removable Storage

DVD+/-RW

DVD-RAM Yes Yes DVD+/-R Yes Yes DVD+/-R DL Yes Yes

Yes

Source SATA DC power receptacle

DC Power Requirement 5 VDC ± 5% 100 mV ripple p-p

> 12 VDC ± 5% 200 mV ripple p-p

Yes

DC Current 5 VDC 1000 mA (typical)

1600 mA (max.)

12 VDC 1200 mA (typical)

2000 mA (max.)

< 2.5W

Total Drive Power (Standby Mode)

SATA Power Connector, 15-pin SATA Data Connector, 7-pin

Markings to identify each connector

Operating Temperature 41° to 122° F (5° to 50° C)

Storage Temperature -22° F to 140° F (-30° C to 60° C) **Environmental**

conditions (all conditions **Relative Humidity** 10% to 90% non-condensing)

86° F (30° C) Maximum Wet Bulb

Temperature

HP DVD-ROM Drive

Height 5.25-inch, half-height, tray-load Orientation Either horizontal or vertical

SATA Interface type

Dimensions 5.8 x 1.7 x 6.9 in (14.8 x 4.2 x 17.5 cm) max

 $(W \times H \times D)$

Weight

Power Supply

Rear Panel

2.1 lb (950 kg) (max)

Performance CD-ROM Read Access time Random 120 ms typical

> **DVD-ROM Read Access** Random 130 ms typical time **Full Stroke** 240 ms typical

Full Stroke

CD Media Read Transfer CD-ROM, CD-R Read Up to 6000 KB/s (40X)

> **CD-RW Read** Up to 4800 KB/s (32X)

200 ms typical

Technical Specifications - Removable Storage

•		•	
		Digital/Analog Audio Playback	Up to 2400 KB/s (16X)
		Digital Audio Extraction (CD-ROM, CD-R)	Up to 6000 KB/s (40X)
		Digital Audio Extraction (CD-RW)	Up to 4800 KB/s (32X)
		Video CD Playback	Up to 2400 KB/s (16X)
	DVD Media Read Transfer	DVD-ROM SL Read	Up to 21600 KB/s (16X)
		DVD-ROM DL Read	Up to 10800 KB/s (8X)
		DVD Video Playback	Up to 10800 KB/s (8X)
		DVD Video SL (other than playback)	Up to 21600 KB/s (16X)
		DVD Video DL (other than playback)	Up to 10800 KB/s (8X)
		DVD+/-R	Up to 21600 KB/s (16X)
		DVD+/-R DL	Up to 10800 KB/s (8X)
		DVD+/-RW	Up to 10800 KB/s (8X)
		DVD-RAM	Up to 6750 KB/s (5X)
Media Compatibility	Media	Read	Write
	CD-ROM	Yes	No
	CD-R	Yes	No
	CD-RW	Yes	No
	DVD-ROM	Yes	No
	DVD-ROM DL	Yes	No
	DVD-RAM	Yes	No
	DVD+/-R	Yes	No
	DVD+/-R DL	Yes	No
	DVD+/-RW	Yes	No
Power Supply	Source	SATA DC power receptacle	
	DC Power Requirement	5 VDC ± 5%	100 mV ripple p-p
		12 VDC ± 5%	200 mV ripple p-p
	DC Current	5 VDC	1000 mA (typical) 1600 mA (max.)
		12 VDC	1200 mA (typical) 2000 mA (max.)
		Total Drive Power (Standby Mode)	< 2.5W
Rear Panel	SATA Power Connector, 15-pin SATA Data Connector, 7-pin Markings to identify each connector		
Environmental conditions	-	41° to 122° F (5° to 50° C)	
(all conditions	Storage Temperature	-22° F to 140° F (-30° C to 60° C)	
non-condensing)	Relative Humidity	10% to 90%	
		10/0 (0 30/0	



HP ProDesk 490 G1 Microtower Business PC

QuickSpecs

Technical Specifications - Removable Storage

Maximum Wet Bulb Temperature 86° F (30° C)



Technical Specifications – Memory

System Memory Support

The HP ProDesk 490 G1 Business PC supports the 4th generation Intel® Core™ processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4th generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) or DDR3/DDR3L unbuffered small
 outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
 - 21.3 GB/s in dual-channel mode assuming 1333 MT/s
 - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

Platform Memory Support

The Microtower platform supports up to four (4) industry-standard DDR3-SDRAM DIMMs.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board. **NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Technical Specifications - Networking and Communications

Realtek RTL8151GH-CG GbE LOM Network Adapter

Connector RJ-45

System Interface Integrated on PCA

Controller Realtek RTL8151GH-CG Gigabit Ethernet Controller

Memory 16 KB FIFO packet buffer memory

Data rates supported 10/100/1000 Mbps

802.1P 802.1Q

IEEE Compliance 802.3 802.3ab

802.3az 802.3u

Bus architecture PCI Express

Power requirementPCIe-based interface for active state operation (S0 state)
Requires 3.3V and 1V or just 3.3V with integrated regulators

Power consumption 0.425 W

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating Temperature: 32° to 158° F (0° to 70° C)

Operating Humidity: 60% RH

Management WOL, auto MDI crossover, PXE, Muti-port teaming, Advanced cable diagnostic

Intel® Ethernet I210-T1 Gigabit Network Adapter

Connector RJ-45

System Interface PCI Express x1

Controller Intel® I210 Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

IEEE Compliance 802.1P

802.1Q 802.2 802.3 802.3AB 802.3u

802.3x flow control

Bus architecture PCI-E 2.1



Technical Specifications - Networking and Communications

Data path width X1, 250 MB/s, Bi-directional interface

Data transfer modeBus-master DMA

Hardware certifications FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union

Power requirement Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T

Boot ROM support Yes

10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps

Network Transfer Rate 100BASE-TX (half-duplex) 100 Mbps

100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Environmental Operating Temperature: 32° to 131°F (0° to 55° C)

Operating Humidity: 85% at 131° F (55° C)

Management WOL, PXE, DMI, WFM 2.0

Intel Dual Band Wireless-N 7260 802.11 a/b/g/n (2x2) Wireless Network Interface Connection

Wireless LAN Standards IEEE 802.11a/b/g/n

Interoperability Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)

Cisco Compatible Extensions Program compliant with Microsoft Windows 7, Windows Vista and XP. NOTE: WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft

Windows Vista.

Frequency Band 802.11b/g/n 2.402-2.482 GHz

802.11a/n 4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

Antenna Structure 2 transmit; 2 receive (2x2)

Data Rates 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM

Security • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI



Technical Specifications - Networking and Communications

Note: Check latest software/driver release for updates on supported security features.

Sub-channels Multinational support with frequency bands and channels compliant to local regulations.

Network Architecture Models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between band Access Points

Output Power • 2.4G: +13.5dBm minimum

• 5G: +12dBm minimum

Note: Maximum output power may vary by country according to local regulations.

Power Consumption Transmit: 2.0 Watts

Receive: 1.6 Watts

Idle mode: 250 mW (WLAN associated) In Power Save Polling mode and on battery power.

Idle mode: 100 mW (WLAN unassociated) Radio off: 100 mW (WLAN unassociated)

Power Management ACPI compliant power management

802.11 compliant power saving mode

Receiver Sensitivity 802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24

Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)

Note: Receiver sensitivity is

of 8% for 802.11b (CCK

modulation) and a packet error rate of 10% for 802.11a/g

(OFDM modulation).

measured at a packet error rate 802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)

802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24

Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)

Antenna Connections 2 U.FL type connectors (output impedance of 50 ± 2 ohms)

Form Factors PCI-Express Half-MiniCard

Weight 0.0068 lb (3.1 q)

0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm) **Dimensions**

Operating Voltage 3.3V +/- 9%

Temperature Operating: 14° to 158° F (-10° to 70° C)

-40° to 176° F (-40° to 80° C) Non-operating:

Humidity Operating: 10% to 90% (non-condensing) Non-operating: 5% to 90% (non-condensing)

LED Amber - Radio OFF; LED White - Radio ON **LED Activity**



Technical Specifications - Audio

High Definition Audio

Type Integrated

HD Stereo Codec Realtek 2-channel ALC221 codec

Audio I/O Ports Front microphone-In (150-K ohm Input Impedance)

Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio

driver)

Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)
Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load)

Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same

signal.

All ports are 3.5mm

Internal Speaker Amplifier 1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear

Line-in audio port is re-taskable as either Line-in or Microphone-In.

Multi-streaming Capable Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to

be sent to/from the front and rear jacks.

Sampling 8 kHz - 192 kHz

Wavetable Syntheses Yes – Uses OS soft wavetable

Analog Audio Yes

of Channels on Line-Out Stereo (Left & Right channels)

Internal Speaker Yes
External Speaker Jack Yes



Technical Specifications – Keyboards and Pointing Devices

HP USB Keyboard

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical characteristics Dimensions (L x W x H) 18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)

Weight 2 lb (0.9 kg)

Operating voltage + 5VDC ± 5 %

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector Electrical

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Environmental Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration
Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 30 in (76.2 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC

Technical Specifications – Keyboards and Pointing Devices

Keyboard Installation Guide
Kit contents

Warranty Card Safety and Comfort Guide

HP PS/2 Keyboard

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical CharacteristicsDimensions

18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)

 $(L \times W \times H)$

Weight 2 lb (0.9 kg) minimum

Operating voltage + 5VDC ± 5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface PS/2 6-pin mini din connector **Electrical**

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 50-dBA maximum sound pressure level

Operating temperature 32° to 104° F (0° to 40° C)

Non-operating temperature -22° to 149° F (-30° to 65° C)

Operating humidity 15% to 80% (non-condensing at ambient)
Non-operating humidity 15% to 90% (non-condensing at ambient)

Operating shock N/A

Environmental Non-operating shock 65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266

inch/second six surface

Operating vibration 2-g peak acceleration

Technical Specifications – Keyboards and Pointing Devices

Non-operating vibration Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz

and back to 5 Hz at a Logarithmic sweep rate of 1 octave per

minute.

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 29.93 in (76 cm) on concrete, 16-drop sequence

Approvals CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

HP USB Smart Card (CCID) Keyboard

Key Benefits:

Protects against unauthorized access with smart card technology

Delivers even greater security when combined with a HP ProtectTools smart card and the HP

ProtectTools Security Software

Combination of username and password or pin with a smart card or security token

Secures online transactions using digital signatures and certificates
 Conforms to industry standards for ease of setup and use

Delivers long product life and quiet operation with high-impact materials and lubricated keys

Spill drain feature

Keys 104, 105, 106, 107, 109 layout

(depending upon country

Form factor USB basic smart card keyboard

Physical Characteristics Colors Carbonite/Silver

Dimensions 18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)

 $(H \times W \times D)$

Weight 2 lb (0.9 kg) minimum

Operating voltage + 5VDC ± 5%

Power consumption 100-mA maximum (with four LEDs ON)

Electrical System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Languages 30+ available
Keycaps Standard design

Switch actuation 55 g nominal peak force with tactile feedback

Switch life 20 million keystrokes

(using Hasco modified tester)

Switch type Contamination-resistant membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)



Mechanical

Environmental

Technical Specifications – Keyboards and Pointing Devices

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient) Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration Non-operating vibration 4-g peak acceleration

Drop 26 in (66 cm) on carpet, six-drop sequence

(out of box)

Drop 42 in (107 cm) on concrete, 16-drop sequence

(in box)

Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4 memory and

microprocessor smart cards (T=0, T=1)

Chipset **SCM STCIII**

Standard APIs supported PC/SC, EMV2000, CT-API

Power **USB Port**

> Short circuit detection (protects smart card and reader) Power supply compliant with ISO7816 and EMV (5V, 60 mA)

Supports 3-V and 5-V cards

SmartCard Function 100-mA maximum draw Power consumption

> Communication From card 9600 bps to 330,000 bps

> > 12 Mbps (USB transfer speed) From computer

Landing mechanism Contact device Friction contact

> Up to 100,000 insertion cycles Card insertions rating

Interface modes **CCID** protocol Reader performance interface **USB** connection

2004/108/EC Electro-magnetic standards Europe

USA USAFCC part 15

CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF **Approvals**

Ergonomic Compliance ISO 9241-4, TUVGS

Kit Contents Keyboard, I/O Security and Documentation CD, warranty card

HP USB PS/2 Washable Keyboard

Keys 104 (US) layout or 105 (EU) layout – depending upon country

Dimensions 17.67x 6.62 x 1.38 in (449 x 168 x 35 mm) **Physical Characteristics**

 $(L \times W \times H)$

Weight 1.7 lb (0.77 kg) minimum

Operating voltage + 5VDC ±5%

Technical Specifications – Keyboards and Pointing Devices

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector Electrical

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Keycaps Stepped -profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 7 ft (2.2 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 95% (non-condensing at ambient)

Non-operating humidity 0% to 95% (non-condensing at ambient)

Environmental Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration
Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Operating system support Windows® 7, Windows Vista, Windows XP Professional

Approvals UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Technical Specifications – Keyboards and Pointing Devices

HP Wireless Keyboard and Mouse

Dimensions (H x L x W) 1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)

Keyboard Weight - Without Two AA 1.94 lb (880 g)

Alkaline Batteries

1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)

Dimensions (H x L x W) Mouse

Alkaline Batteries

Weight - Without Two AA

Dimensions (H x L x W) 0.33 x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)

0.15 lb (67 g)

Weight 0.21 oz (5.9 g) Receiver

> Cable Length - Minimum 6 ft (1.8 m)

Range 32.8 ft (10 m)

Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7 Ultimate Edition

64* Windows Vista or Windows XP Available USB port for the receiver

System Requirements CD-ROM Drive

> *This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

Product Safety UL; CSA /TUV (Europe only); CE Mark; CB Report **Ergonomics** ANSI; ISO (Europe only); GS Mark (Germany only)

EMC FCC; CE; ACA (-tick); BSMI; KC; VCCI

CE Mark EN 55022:2010; EN 55024; EN 301489-1; EN 61000

Design Guidelines for PCs PC 99 - connector overmold colors; PC 2001 - full functionality

Telecom All local telecom requirements and approvals for intended

markets

Approvals USA FCC Title 47 CFR, Par 15, Subpart C; other local requirements

> **Country Support** US, Belgium, Switzerland, Spain, Denmark, Netherlands, France,

> > Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia,

> > Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile,

Argentina, Mexico, South Africa, and up to 193 countries

worldwide.

Technical Specifications – Keyboards and Pointing Devices

HP PS/2 Mouse

Dimensions (H x L x W) 1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)

Weight 3.53 oz (100g; +10g/- 5 g)

Operating temperature -32° to 104°F (0° to 40° C)

Non-operating temperature -4° to 140°F (-20° to 60° C)

Operating humidity 10% to 90%

(non condensing at ambient)

Non-operating humidity 10% to 90%

(non condensing at ambient)

Environmental Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration

Non-operating vibration 4 g peak acceleration

Drop 80 cm height onto asphalt tile over concrete or equivalent, 5-drop

(out of box) in 5 direction except the cable face

Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector **Electrical**

ESD CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft PC99 - 2001 Functionally compliant

Resolution 800 DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

Acceleration ±15%

Switch actuation 65±20 gf

Mechanical Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Tracking mechanism life 80 km

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Width 6 mm

Diameter $22.5 \pm 0.2 \text{ mm}$



Technical Specifications – Keyboards and Pointing Devices

Maximum rotation force 50 gf-cm Scroll wheel

Switch type Light force micro-switch

Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory Approvals UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick

HP USB Mouse

Dimensions (H x L x W)

1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)

Weight 0.22 lb (0.10 kg)

Cable length 70.9 in (180 cm)

System requirements Available USB port

HP USB 1000dpi Laser Mouse

Dimensions 1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)

(HxLxW)

Weight 3.360 oz (102g)

Cable length 70.9 in (180 cm)

System requirements Available USB port

Operating Temperature 32° to 104° F (0° to 40° C)

Environmental Non-operating Temperature -4° to 140° F (-20° to 60° C)

Operating Humidity 10% to 90%

(non-condensing at ambient)

Resolution 1000dpi

Mechanical Tracking Speed 45 cm/sec

Cable Length 70.9 in (180 cm)



Technical Specifications – Keyboards and Pointing Devices

HP USB PS/2 Washable Mouse

Dimensions (H x L x W) 1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)

Weight 4.44 oz (126 g)

Operating temperature -32° to 104°F (0° to 40° C) Non-operating -4° to 140°F (-20° to 60° C)

temperature

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 10% to 90% non-condensing

Environmental Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces
Operating vibration 2 g peak acceleration
Non-operating vibration 4 g peak acceleration

Drop (out of box) 80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5

direction except the cable face

Operating voltage 5 VDC ± 10% Power consumption 100mA

Electrical System consumption PS/2 mini-din connector or USB

ESD CE level 2 8 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC99 – 2001 Functionally compliant Resolution 1000 ± 20% DPI

Tracking speed 14 in/s (35.56 cm/s) maximum

Acceleration 2 g

Mechanical Switch actuation 70 g nominal peak force

Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches
Cable length 8.8 ft total 70 cm+ 2m extension

Microsoft PC99 – 2001 Mechanically compliant

Width 6 mm

Diameter 1 in (25.4 mm)

Scroll wheel Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch
Switch life 3 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant FCC, CE Mark, ICES-003-B, IP66/NEMA4X



Technical Specifications – Power

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure. and the same operating guidelines listed above will still apply.

Operating: 50° to 95° F (10° to 35° C)* **Temperature Range**

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Altitude Operating: 10,000 ft (3048 m) (unpressurized) Non-operating: 30,000 ft (9144 m)

Power Supply

Standard Efficiency 300W active PFC (230 VAC input only)

High Efficiency* 300W active PFC 80 PLUS Bronze

82/85/82% efficient at 20/50/100% load (115V)

82/85/82% efficient at 20/50/100% load (230V)

Operating Voltage Range 90 - 264 VAC

Rated Voltage Range 200 - 240 VAC (300W active PFC)

90 - 240 VAC

Rated Line Frequency 50/60 Hz Operating Line Frequency Range 47 - 63 Hz

4A **Rated Input Current** Rated Input Current with Energy Efficient* Power Supply 4A

Current Leakage <900uA / 230Vac (300W PSU)

(NFPA 99)

80mm Fan (300W PSU) Power Supply Fan Power cord length 6.0 ft. (1.83 m)

External Power Adapter

Dimensions N/A



^{*}Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Technical Specifications – Power

Total Cord Length N/A

*High efficiency power supply is a requirement for ENERGY STAR® qualification in conjunction with a select range of processors and modules



Technical Specifications - Weights & Dimensions

Weights & Dimensions

(configured with 1 HDD & 1 ODD)

Chassis (W x H x D) 182.88 x 357 x 402 mm

7.2 x 14.05 x 15.82 in

System Volume 24.66 L
System Weight* 7.148 kg

15.75 lb

Max Supported Weight N/A

(desktop orientation)

Tower Stand N/A (H x W x D)

Packaged (H x W x D) 535 x 289 x 500 mm

21.06 x 11.37 x 19.68 in

Shipping Weight* Est. = ~10.7 kg (packaged)

~23.58 lb

Palletization Profile 4-units per layer

8-layer max. 32-units per pallet



Technical Specifications – Miscellaneous Features

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls
 system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state
 without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - O Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 -- memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, bootblock recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connector
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



Technical Specifications – Miscellaneous Features

Additional Features	Description
---------------------	-------------

Towerable Orientation Product can be oriented as either a desktop (horizontal) or a tower (vertical)

Implementation of the industry standard ATA Security feature set. When enabled, it **Drive Lock**

prevents software access to user data on the drive until one or two user-defined

passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self test. It scans critical physical components and every sector of

the hard drive for physical faults and then reports any faults to the user

Running independently of the operating system, it can be accessed through a Windowsbased diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be

replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types

of failures

SMART Technology (Self-Monitoring,

Analysis and Reporting Technology)

Allows hard drives to monitor their own health and to raise flags if imminent failures were

predicted

Predicts failures before they occur. Tracks fault prediction and failure indication SMART I - Drive Failure Prediction

parameters such as re-allocated sector count, spin retry count, calibration retry count

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against **SMART II - Off-Line Data Collection**

unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with

Defect Reallocation

Drive Protection System

IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard drives Interface in F10 setup provides confirmation of SMART IV support.



Technical Specifications - Environmental Data

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be declarations labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT Gold registered in the United States. See http://www.epeat.net for registration status in your country.

Tower

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Ultra-slim Desktop model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test method)

metnoa)	115VAC, 60HZ	230VAC, 50HZ	100VAC, 60HZ
Normal Operation	26.12 W	24.96 W	24.04 W
Sleep	1.34 W	1.43 W	1.39 W
Off	0.83 W	0.90 W	0.82 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	89 BTU/hr	85 BTU/hr	82 BTU/hr
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Sound Pressure

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

ISO 7779 and ISO 9296)(LWAd, bels)(LpAm, decibels)Typically Configured - Idle3.723Fixed Disk - Random writes3.723

Sound Power

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 10 USB ports
- · 4 memory slots
- 3 Mini PCIe half-length slot
- 1 Mini PCIe slot
- 1 "internal bay supporting either one 2.5" or one 3.5 hard drives (HDD/SSD/SED/SSHD)
- 15.25" external supporting optical drive



Technical Specifications – Environmental Data

Spare parts are available throughout the warranty period and or for up to "5" years after the end of

production.

Batteries This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 10.5% post-consumer recycled plastic (by wt.)
- This product is 91.8% recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated 2380 g
- Internal:
 - PLASTIC/EPE (Expanded Polyethylene) 185 g
 - PLASTIC/Polyethylene low density 45 g
 - PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material is made from 54.7% recycled content.
- The PLASTIC/EPE (Expanded Polyethylene) packaging materials contains at least 19.5% recycled content.
- The PLASTIC/Polyethylene low density packaging materials contains at least 19.5% recycled content.
- The PLASTIC/Polypropylene packaging materials contains at least 19.5% recycled content.

Common to all Form Factors

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates



Technical Specifications - Environmental Data

- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_

ISO_14K_Certificate.pdf

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Options and Accessories (sold separately)

Communication DevicesPart NumberIntel Ethernet I210 - T1 Gbe NICE0X95AAIntel 6205 802.11 a/b/g/n PCIe x1 NICE0X93AA

NOTE: The use of any of these optional NIC Cards (wired or wireless) will disable the Intel vPro Technology features.

Graphics Solutions	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)	E1C63AA
AMD Radeon HD 8490 Graphics Card	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)	E1C65AA
HP DisplayPort Cable Kit	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	NR078AA
HP DisplayPort To DVI-D Adapter	FH973AA
HP DisplayPort to HDMI Adapter	BP937AA
HP DisplayPort to VGA Adapter	AS615AA
HP DMS-59 to Dual DVI Cable	DL139A
HP DMS-59 to Dual DisplayPort Adapter	XP688AA

Data Storage Drives and Accessories Part Number HP 2TB 7200rpm SATA 6.0Gb/s Hard Disk Drive HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive QK555AA HP 1-TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive C2T91AA HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive QK554AA HP 128-GB SATA 3.0Gb/s Solid State Drive QV063AA HP 160-GB SATA 3.0Gb/s Solid State Drive QV064AA* HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive E1C62AA HP Slim Removable SATA Hard Drive Enclosure (frame & carrier) C1N41AA HP Slim Removable SATA Hard Drive Enclosure (carrier only) E3F39AA HP Chassis (1bay) Security Kit AR639AA



^{*}Not available in all regions.

Options and Accessories (sold separately)

Input Devices	Part Number
HP USB Keyboard	QY776AA
HP USB Gray Keyboard	B6B64AA
HP USB Smart Card (CCID) Keyboard	BV813AA
HP USB Keyboard and Mouse Kit	B1T09AA
HP USB Washable Keyboard	VF097AA
HP USB and PS/2 Washable Mouse	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	BU207AA
HP PS/2 Mouse	QY775AA
HP USB Mouse	QY777AA
HP USB 1000dpi Laser Mouse	QY778AA
HP Wireless Keyboard and Mouse Combination	QY449AA
System Memory	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM	B4U37AA
Multimedia Devices	Part Number
HP Slim DVD-ROM Drive	VP033AA
HP Slim SuperMulti DVD Writer Drive	QS209AA
HP USB HD 720P v2 Business Webcam	D8Z08AA
HP Business Headset	QK550AA
Removable Media Storage	Part Number
HP 14-in-1 Media Card Reader (available Dec. 2013)	TBD
Security Devices	Part Number
HP SFF Wall Mount/Security Sleeve	VN570AA
HP UltraSlim Cable Lock	H4D73AA



Options and Accessories (sold separately)

Stands and Accessories	Part Number
HP Integrated Work Center Stand (SFF)	QP897AA
HP SFF Tower Stand	VN569AA
HP 490 Tower Bezel Kit	E1C66AA
HP 490 SFF Bezel Kit	E3F27AA
HP Serial Port Adapter (RS-232 compatible)	PA716A
HP Parallel Port Kit	KD061AA
HP PCI Expansion Kit	E1V16AA

Business Monitors	Part Number
HP ProDisplay P191	C9E54AA
HP ProDisplay P201	C9F26AA
HP ProDisplay P221	C9E49AA
HP EliteDisplay E201	C9V73AA
HP EliteDisplay E221	C9V76AA
HP EliteDisplay E231	C9V75AA
HP LA2405x	DOP36AA
HP EliteDisplay E271i	D7Z72AA
HP EliteDisplay E221c	D9E49AA

LANDesk Software (E-Delivery)

HP L2206tm

Contact your HP representative for available options.

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BOL55AA